

08-02-2002



Docket No.: FP02-062US

EET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

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102177463

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copies thereof.

1. Name of conveying party(ies):

Hitoshi Takanashi

7-10-02

2. Name and address of receiving party(ies):

Name: Sumitomo Wiring Systems, Ltd.

Address: 1-14, Nishisuehiro-cho

10/193492
07/10/02

Additional names(s) of conveying party(ies)

Yes No

3. Nature of conveyance:

Assignment

Merger

Security Agreement

Change of Name

Other

City: Yokkaichi-City

State/Prov.: Mie

Country: JAPAN

ZIP: 510-8503

Execution Date: June 28, 2002

Additional name(s) & address(es)

Yes No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: June 28, 2002

Patent Application No.

Filing date

B. Patent No.(s)

10,193492

Additional numbers

Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Gerald E. Hespos

Registration No. 30,066

Address: 274 Madison Avenue - Suite 1703

08/02/2002 LNUJELER 00000001 10193492

01 FC:581

40.00 OP

City: New York

State/Prov.: NY

Country: USA

ZIP: 10016

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

Enclosed - Any excess or insufficiency should be credited or debited to deposit account

Authorized to be charged to deposit account

8. Deposit account number:

03-1030

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Gerald E. Hespos

July 10, 2002

Name of Person Signing

Signature

2

Date

Total number of pages including cover sheet, attachments, and

Atty. Ref.: FP02-062U6

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "A WEAR-DETECTING PROBE AND A BRAKING ELEMENT PROVIDED THEREWITH", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patents which may be granted therefor in said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patents to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

Signed and sealed this 21 day of June, 2002.

Hitoshi Takanashi L.S.
Hitoshi Takanashi